



October 1997
Revised June 2005

74VCX16373

Low Voltage 16-Bit Transparent Latch with 3.6V Tolerant Inputs and Outputs

General Description

The VCX16373 contains sixteen non-inverting latches with 3-STATE outputs and is intended for bus oriented applications. The device is byte controlled. The flip-flops appear to be transparent to the data when the Latch Enable (LE) is HIGH. When LE is LOW, the data that meets the setup time is latched. Data appears on the bus when the Output Enable (\overline{OE}) is LOW. When \overline{OE} is HIGH, the outputs are in a high impedance state.

The 74VCX16373 is designed for low voltage (1.2V to 3.6V) V_{CC} applications with I/O compatibility up to 3.6V.

The 74VCX16373 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining low CMOS power dissipation.

Features

- 1.2V to 3.6V V_{CC} supply operation
- 3.6V tolerant inputs and outputs
- t_{PD} (I_n to O_n)
 - 3.0 ns max for 3.0V to 3.6V V_{CC}
- Power-off high impedance inputs and outputs
- Support live insertion and withdrawal (Note 1)
- Static Drive (I_{OH}/I_{OL})
 - ± 24 mA @ 3.0V V_{CC}
- Uses patented noise/EMI reduction circuitry
- Latch-up performance exceeds 300 mA
- ESD performance:
 - Human body model > 2000V
 - Machine model > 200V
- Also packaged in plastic Fine-Pitch Ball Grid Array (FBGA) (Preliminary)

Note 1: To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pull-up resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

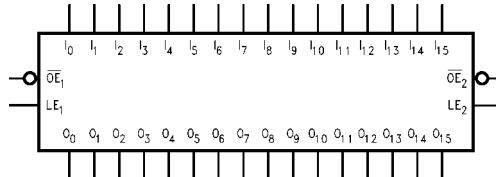
Ordering Code:

Order Number	Package Number	Package Description
74VCX16373G (Note 2)(Note 3)	BGA54A (Preliminary)	54-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide
74VCX16373MTD (Note 3)	MTD48	48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

Note 2: Ordering Code "G" indicates Trays.

Note 3: Devices also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

Logic Symbol

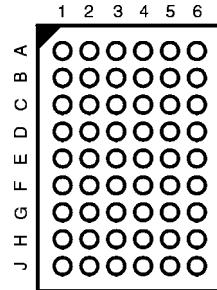


Connection Diagrams

Pin Assignment for TSSOP

\overline{OE}_1	1	48	LE ₁
O ₀	2	47	I ₀
O ₁	3	46	I ₁
GND	4	45	GND
O ₂	5	44	I ₂
O ₃	6	43	I ₃
V _{CC}	7	42	V _{CC}
O ₄	8	41	I ₄
O ₅	9	40	I ₅
GND	10	39	GND
O ₆	11	38	I ₆
O ₇	12	37	I ₇
O ₈	13	36	I ₈
O ₉	14	35	I ₉
GND	15	34	GND
O ₁₀	16	33	I ₁₀
O ₁₁	17	32	I ₁₁
V _{CC}	18	31	V _{CC}
O ₁₂	19	30	I ₁₂
O ₁₃	20	29	I ₁₃
GND	21	28	GND
O ₁₄	22	27	I ₁₄
O ₁₅	23	26	I ₁₅
\overline{OE}_2	24	25	LE ₂

Pin Assignment for FBGA



(Top Thru View)

Pin Descriptions

Pin Names	Description
\overline{OE}_n	Output Enable Input (Active LOW)
LE _n	Latch Enable Input
I ₀ -I ₁₅	Inputs
O ₀ -O ₁₅	Outputs
NC	No Connect

FBGA Pin Assignments

	1	2	3	4	5	6
A	O ₀	NC	\overline{OE}_1	LE ₁	NC	I ₀
B	O ₂	O ₁	NC	NC	I ₁	I ₂
C	O ₄	O ₃	V _{CC}	V _{CC}	I ₃	I ₄
D	O ₆	O ₅	GND	GND	I ₅	I ₆
E	O ₈	O ₇	GND	GND	I ₇	I ₈
F	O ₁₀	O ₉	GND	GND	I ₉	I ₁₀
G	O ₁₂	O ₁₁	V _{CC}	V _{CC}	I ₁₁	I ₁₂
H	O ₁₄	O ₁₃	NC	NC	I ₁₃	I ₁₄
J	O ₁₅	NC	\overline{OE}_2	LE ₂	NC	I ₁₅

Truth Tables

Inputs			Outputs
LE ₁	\overline{OE}_1	I ₀ -I ₇	O ₀ -O ₇
X	H	X	Z
H	L	L	L
H	L	H	H
L	L	X	O ₀

Inputs			Outputs
LE ₂	\overline{OE}_2	I ₈ -I ₁₅	O ₈ -O ₁₅
X	H	X	Z
H	L	L	L
H	L	H	H
L	L	X	O ₀

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial (HIGH or LOW, inputs may not float)

Z = High Impedance

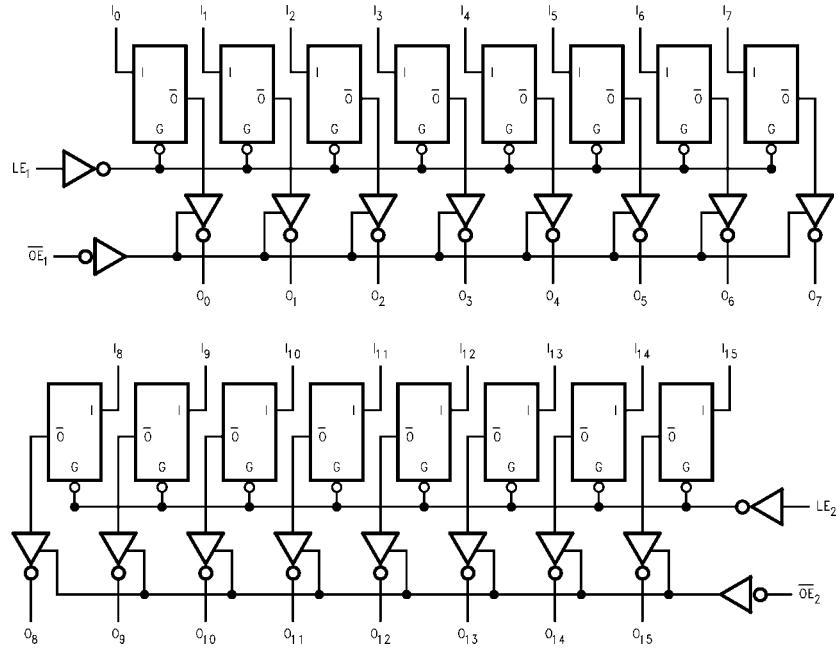
O₀ = Previous O₀ before HIGH-to-LOW of Latch Enable

Functional Description

The 74VCX16373 contains sixteen edge D-type latches with 3-STATE outputs. The device is byte controlled with each byte functioning identically, but independent of the other. Control pins can be shorted together to obtain full 16-bit operation. The following description applies to each byte. When the Latch Enable (LE_n) input is HIGH, data on the I_n enters the latches. In this condition the latches are transparent, i.e., a latch output will change state each time

its I input changes. When LE_n is LOW, the latches store information that was present on the I inputs a setup time preceding the HIGH-to-LOW transition on LE_n . The 3-STATE outputs are controlled by the Output Enable (\overline{OE}_n) input. When \overline{OE}_n is LOW the standard outputs are in the 2-state mode. When \overline{OE}_n is HIGH, the standard outputs are in the high impedance mode but this does not interfere with entering new data into the latches.

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

74VCX16373

Absolute Maximum Ratings ^(Note 4)		Recommended Operating Conditions ^(Note 6)				
Supply Voltage (V_{CC})	-0.5V to +4.6V	Power Supply				
DC Input Voltage (V_I)	-0.5V to +4.6V	Operating	1.2V to 3.6V			
Output Voltage (V_O)		Input Voltage	-0.3V to +3.6V			
Outputs 3-STATED	-0.5V to +4.6V	Output Voltage (V_O)				
Outputs Active (Note 5)	-0.5V to $V_{CC} + 0.5V$	Output in Active States	0.0V to V_{CC}			
DC Input Diode Current (I_{IK}) $V_I < 0V$	-50 mA	Output in "OFF" State	0.0V to 3.6V			
DC Output Diode Current (I_{OK})		Output Current in I_{OH}/I_{OL}				
$V_O < 0V$	-50 mA	$V_{CC} = 3.0V$ to 3.6V	± 24 mA			
$V_O > V_{CC}$	+50 mA	$V_{CC} = 2.3V$ to 2.7V	± 18 mA			
DC Output Source/Sink Current (I_{OH}/I_{OL})	± 50 mA	$V_{CC} = 1.65V$ to 2.3V	± 6 mA			
DC V_{CC} or GND Current per Supply Pin (I_{CC} or GND)	± 100 mA	$V_{CC} = 1.4V$ to 1.6V	± 2 mA			
Storage Temperature Range (T_{STG})	-65°C to +150°C	$V_{CC} = 1.2V$	± 100 mA			
Free Air Operating Temperature (T_A)		Free Air Operating Temperature (T_A)	-40°C to +85°C			
Minimum Input Edge Rate ($\Delta t/\Delta V$)		Minimum Input Edge Rate ($\Delta t/\Delta V$)				
$V_{IN} = 0.8V$ to 2.0V, $V_{CC} = 3.0V$		$V_{IN} = 0.8V$ to 2.0V, $V_{CC} = 3.0V$	10 ns/V			
Note 4: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.						
Note 5: I_O Absolute Maximum Rating must be observed.						
Note 6: Floating or unused inputs must be held HIGH or LOW.						
DC Electrical Characteristics						
Symbol	Parameter	Conditions	V_{CC} (V)	Min	Max	
V_{IH}	HIGH Level Input Voltage		2.7 - 3.6 2.3 - 2.7 1.65 - 2.3 1.4 - 1.6 1.2	2.0 1.6 $0.65 \times V_{CC}$ $0.65 \times V_{CC}$ $0.65 \times V_{CC}$		V
V_{IL}	LOW Level Input Voltage		2.7 - 3.6 2.3 - 2.7 1.65 - 2.3 1.4 - 1.6 1.2	0.8 0.7 $0.35 \times V_{CC}$ $0.35 \times V_{CC}$ $0.15 \times V_{CC}$		V
V_{OH}	HIGH Level Output Voltage	$I_{OH} = -100 \mu A$ $I_{OH} = -12 mA$ $I_{OH} = -18 mA$ $I_{OH} = -24 mA$	2.7 - 3.6 2.7 3.0 3.0	2.2 2.4 2.2		V
		$I_{OH} = -100 \mu A$ $I_{OH} = -6 mA$ $I_{OH} = -12 mA$ $I_{OH} = -18 mA$	2.3 - 2.7 2.3 2.3 2.3	2.0 1.8 1.7		
		$I_{OH} = -100 \mu A$ $I_{OH} = -6 mA$	1.65 - 2.3 1.65	1.25		
		$I_{OH} = -100 \mu A$ $I_{OH} = -2 mA$	1.4 - 1.6 1.4	1.05		
		$I_{OH} = -100 \mu A$	1.2	$V_{CC} - 0.2$		

DC Electrical Characteristics (Continued)

Symbol	Parameter	Conditions	V _{CC} (V)	Min	Max	Units
V _{OL}	LOW Level Output Voltage	I _{OL} = 100 µA	2.7 - 3.6		0.2	
		I _{OL} = 12 mA	2.7		0.4	
		I _{OL} = 18 mA	3.0		0.4	
		I _{OL} = 24 mA	3.0		0.55	
		I _{OL} = 100 µA	2.3 - 2.7		0.2	
		I _{OL} = 12 mA	2.3		0.4	
		I _{OL} = 18 mA	2.3		0.6	
		I _{OL} = 100 µA	1.65 - 2.3		0.2	
		I _{OL} = 6 mA	1.65		0.3	
		I _{OL} = 100 µA	1.4 - 1.6		0.2	
		I _{OL} = 2 mA	1.4		0.35	
		I _{OL} = 100 µA	1.2		0.05	
I _I	Input Leakage Current	0 ≤ V _I ≤ 3.6V	1.2 - 3.6		±5.0	µA
I _{OZ}	3-STATE Output Leakage	0 ≤ V _O ≤ 3.6V V _I = V _{IH} or V _{IL}	1.2 - 3.6		±10.0	µA
I _{OFFI}	Power-OFF Leakage Current	0 ≤ (V _I , V _O) ≤ 3.6V	0		10.0	µA
I _{CC}	Quiescent Supply Current	V _I = V _{CC} or GND V _{CC} ≤ (V _I , V _O) ≤ 3.6V (Note 7)	1.2 - 3.6 1.2 - 3.6		20.0 ±20.0	µA
ΔI _{CC}	Increase in I _{CC} per Input	V _{IH} = V _{CC} - 0.6V	2.7 - 3.6		750	µA

Note 7: Outputs disabled or 3-STATE only.

AC Electrical Characteristics (Note 8)

Symbol	Parameter	Conditions	V _{CC} (V)	T _A = -40°C to +85°C,		Units	Figure Number
				Min	Max		
t _{PHL} , t _{PLH}	Propagation Delay LE to O _n	C _L = 30 pF, R _L = 500Ω	3.3 ± 0.3	0.8	3.0	ns	Figures 1, 2
			2.5 ± 0.2	1.0	3.9		
			1.8 ± 0.15	1.5	7.8		
	Propagation Delay I _n to O _n	C _L = 15 pF, R _L = 2kΩ	1.5 ± 0.1	1.0	15.6	ns	Figures 7, 8
			1.2	1.5	39.0		
			1.8 ± 0.15	1.5	6.8		
t _{PZL} , t _{PZH}	Output Enable Time	C _L = 30 pF, R _L = 500Ω	3.3 ± 0.3	0.8	3.0	ns	Figures 1, 2
			2.5 ± 0.2	1.0	3.4		
			1.8 ± 0.15	1.5	6.8		
	C _L = 15 pF, R _L = 2kΩ	C _L = 30 pF, R _L = 500Ω	1.5 ± 0.1	1.0	13.6	ns	Figures 7, 8
			1.2	1.5	34.0		
			1.8 ± 0.15	1.5	9.2		
t _{PLZ} , t _{PHZ}	Output Disable Time	C _L = 30 pF, R _L = 500Ω	3.3 ± 0.3	0.8	3.5	ns	Figures 1, 3, 4
			2.5 ± 0.2	1.0	4.6		
			1.8 ± 0.15	1.5	9.2		
	C _L = 15 pF, R _L = 2kΩ	C _L = 15 pF, R _L = 2kΩ	1.5 ± 0.1	1.0	18.4	ns	Figures 7, 9, 10
			1.2	1.5	46.0		
			1.8 ± 0.15	1.5	6.8		
T _S	Setup Time	C _L = 30 pF, R _L = 500Ω	3.3 ± 0.3	0.8	3.5	ns	Figures 1, 3, 4
			2.5 ± 0.2	1.0	3.8		
			1.8 ± 0.15	1.5	6.8		
		C _L = 15 pF, R _L = 2kΩ	1.5 ± 0.1	1.0	13.6	ns	Figures 7, 9, 10
			1.2	1.5	34.0		
		1.8 ± 0.15	2.5				
		C _L = 15 pF, R _L = 2kΩ	1.5 ± 0.1	3.0		ns	Figures 6, 7
			1.2	6.0			

AC Electrical Characteristics (Continued)

Symbol	Parameter	Conditions	V _{CC} (V)	T _A = -40°C to +85°C, Min Max		Units	Figure Number
				Min	Max		
T _H	Hold Time	C _L = 30 pF, R _L = 500Ω	3.3 ± 1.0	1.0		ns	Figures 1, 6
			2.5 ± 0.2	1.0			
			1.8 ± 0.15	1.0			
	T _W	C _L = 15 pF, R _L = 2kΩ	1.5 ± 0.1	1.2		ns	Figures 6, 7
			1.2	3.6			
			1.8 ± 0.15	4.0			
t _{OSHL} t _{OSLH}	Output to Output Skew (Note 9)	C _L = 30 pF, R _L = 500Ω	3.3 ± 0.3	1.5		ns	Figures 1, 4
			2.5 ± 0.2	1.5			
			1.8 ± 0.15	4.0			
		C _L = 15 pF, R _L = 2kΩ	1.5 ± 0.1	4.0		ns	Figures 4, 7
			1.2	8.0			
			1.8 ± 0.15	4.0			

Note 8: For C_L = 50 pF, add approximately 300 ps to the AC maximum specification.

Note 9: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}).

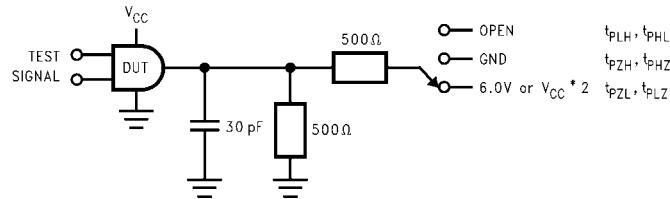
Dynamic Switching Characteristics

Symbol	Parameter	Conditions	V _{CC} (V)	T _A = +25°C		Units
				Typical		
V _{OLP}	Quiet Output Dynamic Peak V _{OL}	C _L = 30 pF, V _{IH} = V _{CC} , V _{IL} = 0V	1.8	0.25		V
			2.5	0.6		
			3.3	0.8		
V _{OLV}	Quiet Output Dynamic Valley V _{OL}	C _L = 30 pF, V _{IH} = V _{CC} , V _{IL} = 0V	1.8	-0.25		V
			2.5	-0.6		
			3.3	-0.8		
V _{OHV}	Quiet Output Dynamic Valley V _{OH}	C _L = 30 pF, V _{IH} = V _{CC} , V _{IL} = 0V	1.8	1.5		V
			2.5	1.9		
			3.3	2.2		

Capacitance

Symbol	Parameter	Conditions	T _A = +25°C		Units
			Typical		
C _{IN}	Input Capacitance	V _{CC} = 1.8V, 2.5V or 3.3V, V _I = 0V or V _{CC}	6.0		pF
C _{OUT}	Output Capacitance	V _I = 0V or V _{CC} , V _{CC} = 1.8V, 2.5V or 3.3V	7.0		pF
C _{PD}	Power Dissipation Capacitance	V _I = 0V or V _{CC} , f = 10 MHz, V _{CC} = 1.8V, 2.5V or 3.3V	20.0		pF

AC Loading and Waveforms ($V_{CC} 3.3V \pm 0.3V$ to $1.8V \pm 0.15V$)



TEST	SWITCH
t_{PLH}, t_{PHL}	Open
t_{PZH}, t_{PLZ}	6V at $V_{CC} = 3.3 \pm 0.3V$; $V_{CC} \times 2$ at $V_{CC} = 2.5 \pm 0.2V; 1.8V \pm 0.15V$
t_{PZL}, t_{PHZ}	GND

FIGURE 1. AC Test Circuit

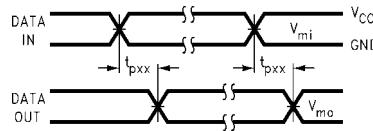


FIGURE 2. Waveform for Inverting and Non-Inverting Functions

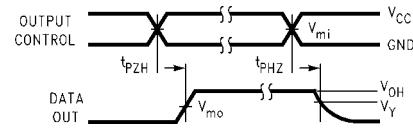


FIGURE 3. 3-STATE Output HIGH Enable and Disable Times for Low Voltage Logic

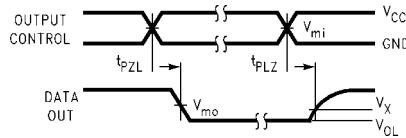


FIGURE 4. 3-STATE Output LOW Enable and Disable Times for Low Voltage Logic

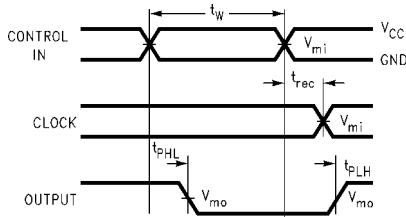


FIGURE 5. Propagation Delay, Pulse Width and trec Waveforms

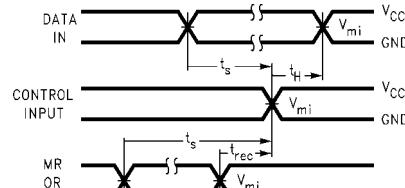
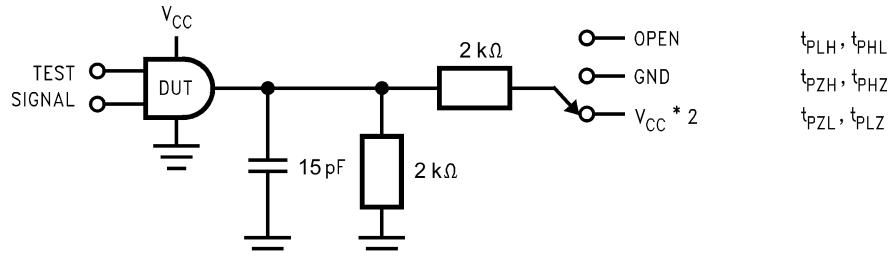


FIGURE 6. Setup Time, Hold Time and Recovery Time for Low Voltage Logic

Symbol	V_{CC}		
	$3.3V \pm 0.3V$	$2.5V \pm 0.2V$	$1.8V \pm 0.15V$
V_{mi}	1.5V	$V_{CC}/2$	$V_{CC}/2$
V_{mo}	1.5V	$V_{CC}/2$	$V_{CC}/2$
V_X	$V_{OL} + 0.3V$	$V_{OL} + 0.15V$	$V_{OL} + 0.15V$
V_Y	$V_{OH} - 0.3V$	$V_{OH} - 0.15V$	$V_{OH} - 0.15V$

AC Loading and Waveforms ($V_{CC} 1.5 \pm 0.1V$ to $1.2V$)

TEST	SWITCH
t_{PLH}, t_{PHL}	Open
t_{PZH}, t_{PLZ}	$V_{CC} \times 2$ at $V_{CC} = 1.5 \pm 0.1V$
t_{PZL}, t_{PHZ}	GND

FIGURE 7. AC Test Circuit

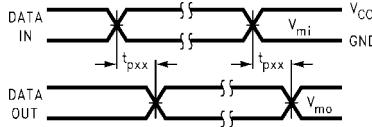


FIGURE 8. Waveform for Inverting and Non-Inverting Functions

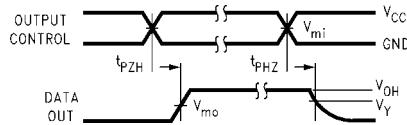


FIGURE 9. 3-STATE Output High Enable and Disable Times for Low Voltage Logic

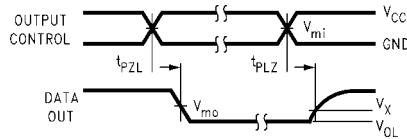
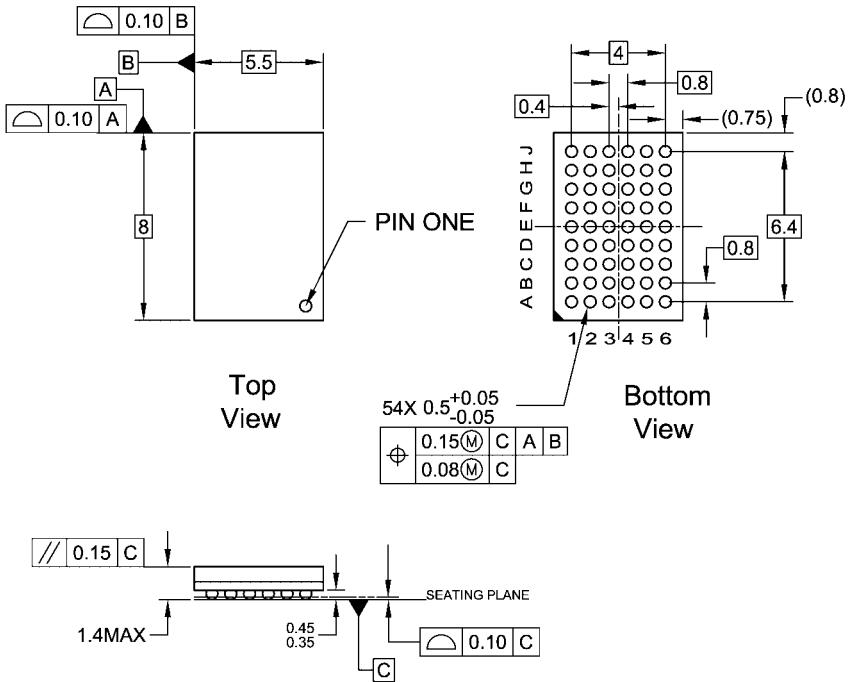


FIGURE 10. 3-STATE Output Low Enable and Disable Times for Low Voltage Logic

Symbol	V_{CC}
	$1.5V \pm 0.1V$
V_{mi}	$V_{CC}/2$
V_{mo}	$V_{CC}/2$
V_X	$V_{OL} + 0.1V$
V_Y	$V_{OH} - 0.1V$

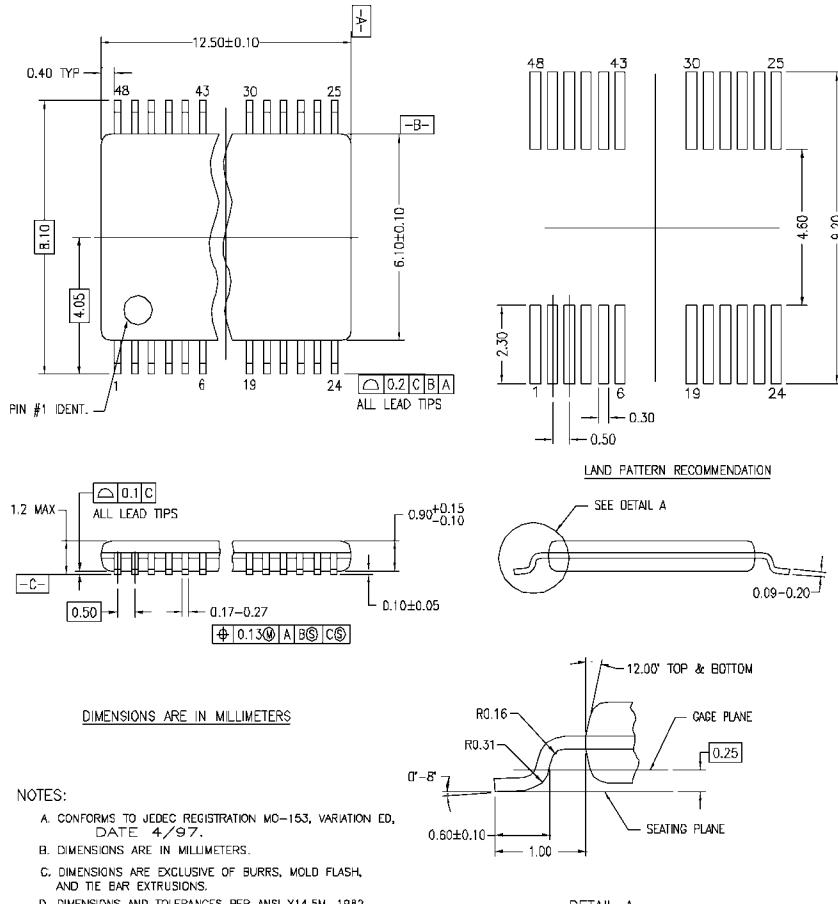
Physical Dimensions inches (millimeters) unless otherwise noted



BGA54RevD

54-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC M0-205, 5.5mm Wide
Package Number BGA54A
(Preliminary)

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



MTD48REVC

**48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide
Package Number MTD48**

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